







#### **Description**

The B0310J50100A00 is a low cost, low profile sub-miniature unbalanced to balanced transformer designed for differential inputs and output locations on modern chipsets in an easy to use surface mount. The B0310J50100A00 is ideal for high volume manufacturing and delivers higher performance than traditional wire wound baluns. The B0310J50100A00 has an unbalanced port impedance of  $50\Omega$  and a  $100\Omega$  balanced port impedance\*. This transformation enables single ended signals to be applied to differential ports on modern integrated chipsets. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B0310J50100A00 is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

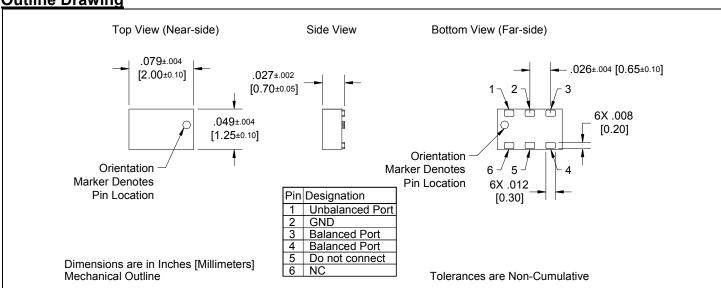
#### **Features:**

- 300 1000 MHz
- 0.7mm Height Profile
- 50 Ohm to 2 x 50 Ohm
- Input to Output DC Isolation
- Surface Mountable
- Tape & Reel
- Non-conductive Surface
- RoHS Compliant

	ROOM (25°C)			
Parameter	Min.	Тур.	Max	Unit
Frequency	300		1000	MHz
Unbalanced Port Impedance		50		Ω
Balanced Port Impedance		100		Ω
Return Loss	8.1	9.4		dB
Insertion Loss*		8.0	1.0	dB
Amplitude Balance		2.5	2.8	dB
Phase Balance		34	36	Degrees
CMRR		9		dB
Power Handling			2	Watts
Operating Temperature	-55		+85	°C

<sup>\*</sup> Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1 dB higher at +85 °C)

#### **Outline Drawing**







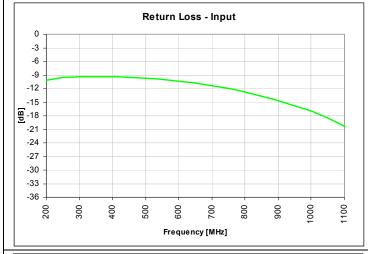
USA/Canada: (315) 432-8909 Toll Free: (800) 411-6596 Europe: +44 2392-232392

# Model B0310J50100A00

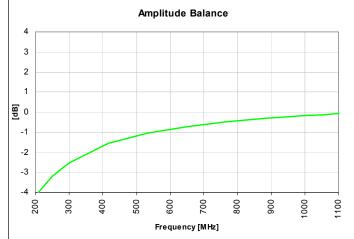
Rev B

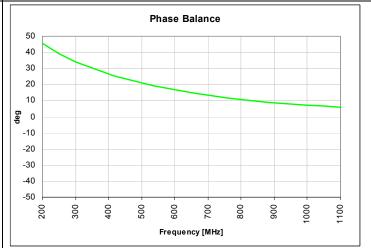


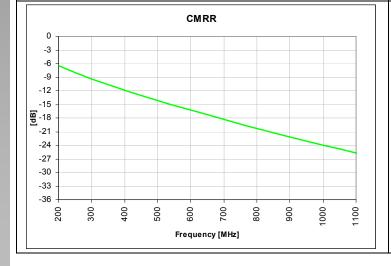
### Typical Performance: 200 MHz. to 1100 MHz.









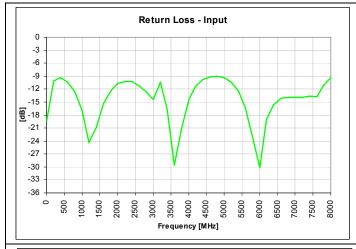




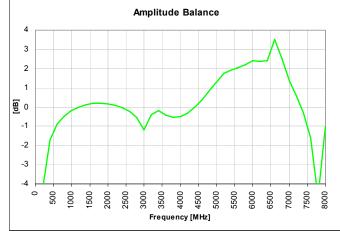


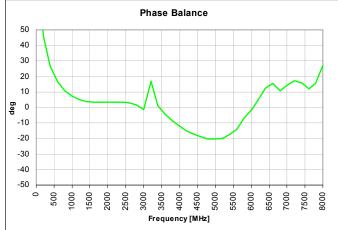


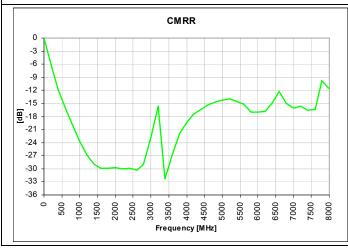
#### Wide Band Performance: 0 MHz. to 8000 MHz.













## Model B0310J50100A00

Rev B



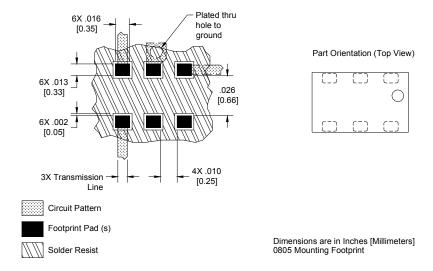
#### **Mounting Configuration:**

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability having X and Y thermal coefficient of expansion (CTE) of 17 ppm/°C.

An example of the PCB footprint used in the testing of these parts is shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.

#### **Mounting Footprint**

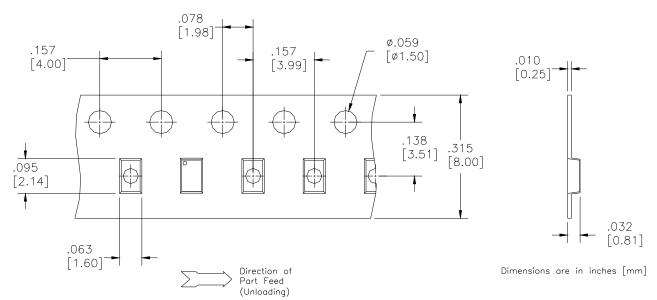


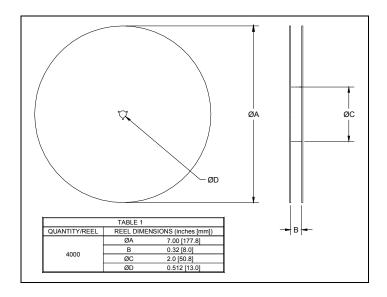




#### **Packaging and Ordering Information**

Parts are available in reel and are packaged per EIA 481-2. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel. See Model Numbers below for further ordering information.







USA/Canada: (315) 432-8909 Toll Free: (800) 411-6596 Europe: +44 2392-232392